## BGA Heat Sink - High Performance maxiFLOW/superGRIP

ATS Part\#:
Description:

| Heat Sink Type: | maxiFLOW |
| :--- | :--- |
| Heat Sink Attachment: | superGRIP |
| Equivalent Part Number: | N/A |

*Image above is for illustration purpose only.

## Features \& Benefits

- Designed for $21 \times 21 \mathrm{~mm}$ components
- Requires minimal space around the component's perimeter; ideal for densely populated PCBs
- Allows the heat sink to be detached and reattached without damaging the component or the $P C B$, an important feature in the event a PCB may need to be reworked
- Strong, uniform attachment force helps achieve maximum performance from phase-changing TIMs
- Eliminates the need to drill mounting holes in the PCB


## Thermal Performance

| AIR VELOCITY |  | $\begin{aligned} & \text { @200 LFM } \\ & \text { 1.0 M/S } \end{aligned}$ | @300 LFM 1.5 M/S | @400 LFM <br> 2.0 M/S | @ 500 LFM 2.5 M/S | @600 LFM <br> 3.0 M/S | @700 LFM 3.5 MIS | @800 LFM 4.0 M/S |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| THERMAL RESISTANCE | Unducted Flow | $11.9{ }^{\circ} \mathrm{C} / \mathrm{W}$ | $9.5{ }^{\circ} \mathrm{C} / \mathrm{W}$ | $8.2{ }^{\circ} \mathrm{C} / \mathrm{W}$ | $7.3{ }^{\circ} \mathrm{C} / \mathrm{W}$ | $6.7{ }^{\circ} \mathrm{C} / \mathrm{W}$ | $6.2{ }^{\circ} \mathrm{C} / \mathrm{W}$ | $5.8{ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | Ducted Flow | 8.8 | N/A | N/A | N/A | N/A | N/A | N/A |

## Product Detail

Dimension A Dimension B

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), sales@qats.com or www.qats.com.

